

# 11.3-Gbps Dual-Channel Cable and PC Board Equalizer

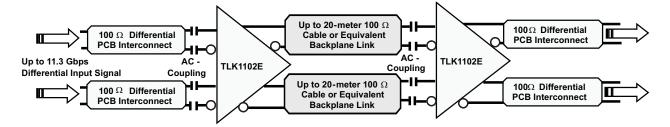
#### **FEATURES**

- Dual-Channel Multi-Rate Operation up to 11.3Gbps
- Two-Wire Serial Interface (with 8 Selectable Device Addresses) or Device Pin Control
- Compensates for up to 30dB Loss on the Receive Side and up to 7dB Loss on the Transmit Side at 5.65GHz
- Adjustable Input Equalization Level
- Adjustable Output De-Emphasis: 0 7dB
- Adjustable Input Bandwidth: 4.5 11GHz
- Adjustable CML Output Swing: 225 -1200mV<sub>p-p</sub>
- Loss of Signal (LOS) Detection
- Output Disable with Selectable Auto-Squelch Function
- Output Polarity Switch
- Excellent High Frequency Input and Output Return Loss

- Surface Mount Small Footprint 4-mm × 4-mm 24-Pin QFN Package
- Single 3.3V Supply
- -40°C to 100°C Operation (Lead Temperature)

#### APPLICATIONS

- High-Speed Links In Communication and Data Systems
- Backplane, Daughtercard, and Cable Interconnects for 10GE, 8GFC, 10GFC, 10G SONET, SAS, SATA, and InfiniBand
- QSFP, SFP+, XFP, SAS, SATA, and InfiniBand Active Cable Assemblies



#### DESCRIPTION

The TLK1102E is a versatile and flexible high-speed dual-channel equalizer for applications in digital high-speed links with data rates up to 11.3Gbps.

The TLK1102E can be configured in many ways through its two-wire serial interface, available through the SDA and the SCL pins, to optimize its performance. The configurable parameters include the output de-emphasis settable from 0 to 7dB, the output differential voltage swing settable from 225 to  $1200 \text{mV}_{\text{p-p}}$ , the input equalization level settable for 0 to 20 meters of 24-AWG twinaxial cable, 0 to 40 inches of FR-4 PCB interconnect, or equivalent interconnect (see Table 1), the input filter bandwidth settable from 4.5 to 11GHz, and the LOS (loss of signal) assert voltage level.



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# **DESCRIPTION (CONTINUED)**

Alternatively, the TLK1102E can be configured using its configuration pins in two modes selectable using the MODE pin. In Pin Control Mode 1 (see Figure 2b), a common setting can be set for the two channels for the output de-emphasis level and the interconnect length using the DE pin and LN0, LN1 pins respectively. In Pin Control Mode 2 (see Figure 2c), those parameters can be set individually for the two channels using DEA, DEB, LNA, and LNB pins. In both modes only a common setting is available for the output voltage swing using the SWG pin. For Pin Control Mode 2 the typical LOS assert and de-assert voltage levels are fixed at  $90\text{mV}_{p-p}$  and  $150\text{mV}_{p-p}$  respectively with 4.0dB hysteresis.

The outputs can be disabled using the DISA and DISB pins. The DISA/DISB pins and the LOSA/LOSB pins can be connected together to implement an external output squelch function. The TLK1102E implements an internal output squelch function that can be enabled using the two-wire serial interface. In addition, a special fast auto-squelch function can be selected through the two-wire serial interface when needed to support SAS and SATA out-of-band (OOB) signals.

The POLA and POLB pins can be used to reverse the polarity of the OUTA+/OUTA- and OUTB+/OUTB- pins respectively.

The high input signal dynamic range ensures low jitter output signals even when overdriven with input signal swings as high as 1600mV<sub>p-p</sub> differential. The low-frequency cut-off is low enough to support low-frequency control signals such as SAS and SATA OOB signals. The loss-of-signal detection and output disable functions are carefully designed to meet SAS/SATA OOB signal timing constraints.

Table 1. Equalization Level Settings

| CABLE LENGTH (meters)<br>(1.8dB/m loss at 5 GHz) | PIN M | ODE 1 | PIN MODE 2    | TWO-WIRE SERIAL I/F MODE (registers 3 and 6) |     |     | _   |
|--|-------|-------|---------------|--|-----|-----|-----|
| (1.oub/iii loss at 3 GHz)                        | LN1   | LN0   | LNA / LNB     | EQ3  | EQ2 | EQ1 | EQ0 |
| 0 – 2  | GND   | GND   | GND           | 1  | 1   | 1   | 1   |
| 2 – 6  | GND   | VCC   | GND           | 0  | 1   | 1   | 1   |
| 6 – 11   | VCC   | GND   | 1.8 MΩ to GND | 0  | 1   | 0   | 1   |
| 11 – 15  | VCC   | VCC   | VCC           | 0  | 0   | 0   | 0   |

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#### **BLOCK DIAGRAM**

A simplified block diagram of the TLK1102E is shown in Figure 1 for the two-wire serial interface control mode. This compact, low power, 11.3-Gbps dual-channel equalizer consists of a high-speed data path with an offset cancellation block combined with an analog input threshold selection circuitry, a loss of signal detection block, a two-wire interface with a control-logic block, a bandgap voltage reference, and a bias current generation block.

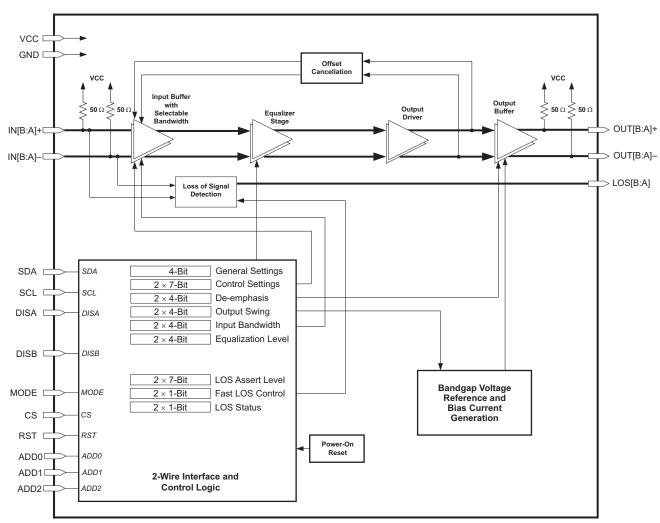


Figure 1. Simplified Block Diagram of the TLK1102E

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#### **PACKAGE**

For the TLK1102E a small footprint 4-mm x 4-mm 24-pin QFN package is used, with a lead pitch of 0.5mm. Three pin-outs are available for this device as shown in Figure 2. The pin-out in Figure 2a is applicable for the case where the device is setup to be controlled through the two-wire serial interface. The pin-outs in Figure 2b and Figure 2c are applicable for the cases where the device is setup to be controlled through the device configuration pins. The MODE pin controls the pinout as described in the TERMINAL FUNCTIONS tables.

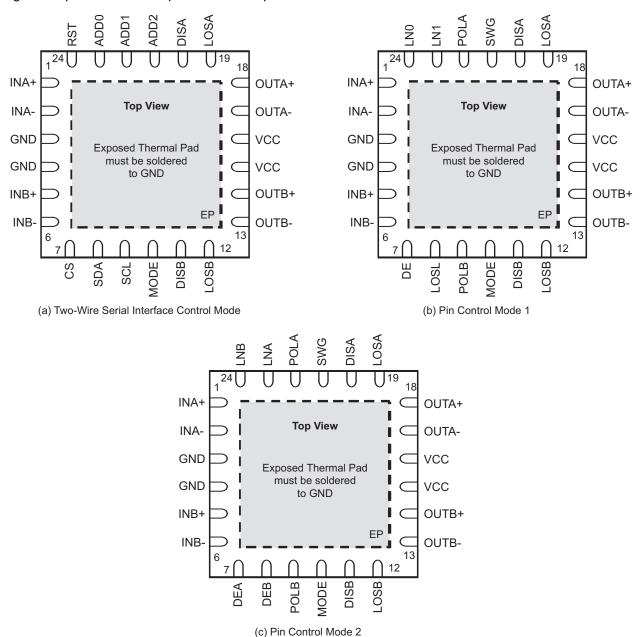


Figure 2. Pin-Out of the TLK1102E in a 4-mm × 4-mm 24-Pin QFN Package

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## **TERMINAL FUNCTIONS - TWO-WIRE SERIAL INTERFACE CONTROL MODE**

Pin descriptions for the TLK1102E in a 4-mm x 4-mm 24-pin QFN package when the device is set to be controlled using the two-wire serial interface. This mode is selected through setting the MODE pin (pin 10) to high level.

| PIN           | SYMBOL              | TYPE           | DESCRIPTION   |
|---------------|---------------------|----------------|---|
| 1, 2          | INA+, INA-          | analog-in      | First pair of differential data inputs. Each pin is on-chip $50\Omega$ terminated to VCC.   |
| 3, 4          | GND                 | supply         | Circuit ground.   |
| 5, 6          | INB+, INB-          | analog-in      | Second pair of differential data inputs. Each pin is on-chip $50\Omega$ terminated to VCC.  |
| 7             | CS                  | digital-in     | Chip Select pin. Disables the two-wire serial interface when set to low level. Internally pulled up.  |
| 8             | SDA                 | digital-in/out | Bidirectional serial data pin for the two-wire serial interface. Open drain. Connect to a $10k\Omega$ pull-up resistor if used. Leave open if unused.   |
| 9             | SCL                 | digital-in     | Serial clock pin for the two-wire serial interface. Connect to a $10k\Omega$ pull-up resistor if used. Leave open if unused. Internally pulled up to VCC with a $500k\Omega$ resistor.  |
| 10            | MODE                | three-state    | Device control mode select. Pull up to VCC for the two-wire serial interface control mode.  |
| 11            | DISB                | digital-in     | Disables CML output stage for OUTB+ and OUTB- when set to high level. Internally pulled down.   |
| 12            | LOSB                | digital-out    | High level indicates that the input signal amplitude on INB+/INB- is below the programmed threshold level. Open drain. Requires an external $10k\Omega$ pull-up resistor to VCC for proper operation.   |
| 13, 14        | OUTB-, OUTB+        | analog-out     | Second pair of differential data outputs. Each pin is on-chip $50\Omega$ terminated to VCC.   |
| 15, 16        | VCC                 | supply         | 3.3V ± 10% supply voltage.  |
| 17, 18        | OUTA-, OUTA+        | analog-out     | First pair of differential data outputs. Each pin is on-chip $50\Omega$ terminated to VCC.  |
| 19            | LOSA                | digital-out    | High level indicates that the input signal amplitude on INA+/INA- is below the programmed threshold level. Open drain. Requires an external $10k\Omega$ pull-up resistor to VCC for proper operation.   |
| 20            | DISA                | digital-in     | Disables CML output stage for OUTA+ and OUTA- when set to high level. Internally pulled down.   |
| 21, 22,<br>23 | ADD2, ADD1,<br>ADD0 | digital-in     | Configurable least significant bits (ADD[2:0]) of the two-wire serial interface device address. The fixed most significant bits (ADD[6:3]) of the 7-bit device address are 0101. The default address is 0101100. These pins are internally pulled up. Pull down externally to invert the associated bits. |
| 24            | RST                 | digital-in     | Reset pin. Resets all the device digital circuits when set to high level. Internally pulled down.   |
| EP            | EP                  |                | Exposed die pad (EP) must be grounded.  |

#### **TERMINAL FUNCTIONS - PIN CONTROL MODE 1**

Pin descriptions for the TLK1102E in a 4-mm x 4-mm 24-pin QFN package when the device is set for Pin Control Mode 1. This mode is selected through setting the MODE pin (pin 10) to low level.

| PIN    | SYMBOL       | TYPE        | DESCRIPTION   |
|--------|--------------|-------------|---|
| 1, 2   | INA+, INA-   | analog-in   | First pair of differential data inputs. Each pin is on-chip $50\Omega$ terminated to VCC.   |
| 3, 4   | GND          | supply      | Circuit ground.   |
| 5, 6   | INB+, INB-   | analog-in   | Second pair of differential data inputs. Each pin is on-chip 50Ω terminated to VCC.   |
| 7      | DE           | analog-in   | Output signal de-emphasis control. A 0 to 1.2-V controlling voltage on this pin adjusts output de-emphasis on OUTA and OUTB pins from 0 to 7dB.   |
| 8      | LOSL         | analog-in   | LOS threshold control. A 0 to 0.7-V controlling voltage on this pin adjusts the LOS assert and de-assert levels on INA and INB pins.  |
| 9      | POLB         | digital-in  | Output data signal polarity select for OUTB+/OUTB- pins. Internally pulled up. Set to high level or leave open for normal polarity. Set to low level for inverted polarity.                           |
| 10     | MODE         | three-state | Device control mode select. Tie to GND for pin control mode 1.  |
| 11     | DISB         | digital-in  | Disables CML output stage for OUTB+ and OUTB- when set to high level. Internally pulled down.   |
| 12     | LOSB         | digital-out | High level indicates that the input signal amplitude on INB+/INB- is below the programmed threshold level. Open drain. Requires an external $10k\Omega$ pull-up resistor to VCC for proper operation. |
| 13, 14 | OUTB-, OUTB+ | analog-out  | Second pair of differential data outputs. Each pin is on-chip 50Ω terminated to VCC.  |
| 15, 16 | VCC          | supply      | 3.3V ± 10% supply voltage.  |
| 17, 18 | OUTA-, OUTA+ | analog-out  | First pair of differential data outputs. Each pin is on-chip $50\Omega$ terminated to VCC.  |

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| PIN    | SYMBOL   | TYPE        | DESCRIPTION  |
|--------|----------|-------------|--|
| 19     | LOSA     | digital-out | High level indicates that the input signal amplitude on INA+/INA- is below the programmed threshold level. Open drain. Requires an external $10k\Omega$ pull-up resistor to VCC for proper operation.              |
| 20     | DISA     | digital-in  | Disables CML output stage for OUTA+ and OUTA- when set to high level. Internally pulled down.  |
| 21     | SWG      | three-state | OUTA, OUTB swing control. Tie to VCC for $1200 mV_{p-p}$ swing, tie to GND for $225 mV_{p-p}$ swing, or pull down with a $1.8 M\Omega$ resistor for $600 mV_{p-p}$ swing.  |
| 22     | POLA     | digital-in  | Output data signal polarity select for OUTB+/OUTB- pins. Internally pulled up. Set to high level or leave open for normal polarity. Set to low level for inverted polarity.  |
| 23, 24 | LN1, LN0 | digital-in  | Equalization level setting. Internally pulled up. Each pin supports two logic levels: high and low – four settings in the following low to high equalization order: LN1=LN0=0; LN1=0 LN0=1; LN1=1 LN0=0; LN1=LN0=1 |
| EP     | EP       |             | Exposed die pad (EP) must be grounded.   |

# **TERMINAL FUNCTIONS - PIN CONTROL MODE 2**

Pin descriptions for the TLK1102E in a 4-mm x 4-mm 24-pin QFN package when the device is set for Pin Control Mode 2. This mode is selected through pulling down the MODE pin (pin 10) with a 1.8-M $\Omega$  resistor.

| PIN    | SYMBOL       | TYPE        | DESCRIPTION  |
|--------|--------------|-------------|--|
| 1, 2   | INA+, INA-   | analog-in   | First pair of differential data inputs. Each pin is on-chip 50Ω terminated to VCC.   |
| 3, 4   | GND          | supply      | Circuit ground.  |
| 5, 6   | INB+, INB-   | analog-in   | Second pair of differential data inputs. Each pin is on-chip $50\Omega$ terminated to VCC.   |
| 7      | DEA          | analog-in   | Output signal de-emphasis control for OUTA. A 0 to 1.2-V controlling voltage on this pin adjusts output de-emphasis on OUTA+/OUTA- pins from 0 to 7dB.   |
| 8      | DEB          | analog-in   | Output signal de-emphasis control for OUTB. A 0 to 1.2-V controlling voltage on this pin adjusts output de-emphasis on OUTB+/OUTB- pins from 0 to 7dB.   |
| 9      | POLB         | digital-in  | Output data signal polarity select for OUTB+/OUTB- pins. Internally pulled up. Set to high level or leave open for normal polarity. Set to low level for inverted polarity.                                      |
| 10     | MODE         | three-state | Device control mode select. Pull down with a 1.8MΩ resistor for pin control mode 2.  |
| 11     | DISB         | digital-in  | Disables CML output stage for OUTB+ and OUTB- when set to high level. Internally pulled down.  |
| 12     | LOSB         | digital-out | High level indicates that the input signal amplitude on INB+/INB- is below the programmed threshold level. Open drain. Requires an external $10k\Omega$ pull-up resistor to VCC for proper operation.            |
| 13, 14 | OUTB-, OUTB+ | analog-out  | Second pair of differential data outputs. Each pin is on-chip $50\Omega$ terminated to VCC.  |
| 15, 16 | VCC          | supply      | 3.3V ± 10% supply voltage.   |
| 17, 18 | OUTA-, OUTA+ | analog-out  | First pair of differential data outputs. Each pin is on-chip $50\Omega$ terminated to VCC.   |
| 19     | LOSA         | digital-out | High level indicates that the input signal amplitude on INA+/INA- is below the programmed threshold level. Open drain. Requires an external $10k\Omega$ pull-up resistor to VCC for proper operation.            |
| 20     | DISA         | digital-in  | Disables CML output stage for OUTA+ and OUTA- when set to high level. Internally pulled down.  |
| 21     | SWG          | three-state | OUTA, OUTB swing control. Tie to VCC for $1200 mV_{p-p}$ swing, tie to GND for $225 mV_{p-p}$ swing, or pull down with a $1.8 M\Omega$ resistor for $600 mV_{p-p}$ swing.  |
| 22     | POLA         | digital-in  | Output data signal polarity select for OUTB+/OUTB- pins. Internally pulled up. Set to high level or leave open for normal polarity. Set to low level for inverted polarity.                                      |
| 23     | LNA          | three-state | Equalization level setting. Supports three equalization settings. Tie to VCC for high setting, tie to GND for low setting, or pull down with $1.8M\Omega$ resistor for medium setting. Internally tied to VCC/2. |
| 24     | LNB          | three-state | Equalization level setting. Supports three equalization settings. Tie to VCC for high setting, tie to GND for low setting, or pull down with $1.8M\Omega$ resistor for medium setting. Internally tied to VCC/2. |
| EP     | EP           |             | Exposed die pad (EP) must be grounded.   |

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## **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted) (1)

|                                       |   | VALUE       | UNIT     |
|---------------------------------------|---|-------------|----------|
| V <sub>CC</sub>                       | Supply voltage <sup>(2)</sup>   | -0.3 to 4.0 | V        |
| V <sub>IN+</sub> , V <sub>IN-</sub>   | Voltage at INA+, INA-, INB+, INB-(2)                                  | 0.5 to 4.0  | V        |
| $V_{IO}$                              | Voltage at pin 7 to 11 and pin 20 to 24 <sup>(2)</sup>                | -0.3 to 4.0 | ٧        |
| $V_{IN,DIFF}$                         | Differential voltage between INA+ and INA-, and between INB+ and INB- | ±2.5        | ٧        |
| $I_{IN+}, I_{IN-}$                    | Continuous current at data inputs                                     | -25 to 25   | mA       |
| I <sub>OUT+</sub> , I <sub>OUT-</sub> | Continuous current at data outputs                                    | -35 to 35   | mA       |
| I <sub>LOS</sub>                      | Sink current at LOSA and LOSB outputs                                 | 25          | mA       |
| ESD                                   | ESD rating at all pins  | 2.5         | kV (HBM) |
| $T_{J,max}$                           | Maximum junction temperature  | 125         | °C       |

<sup>(1)</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute—maximum—rated conditions for extended periods may affect device reliability.

#### RECOMMENDED OPERATING CONDITIONS

|                 |                            | MIN  | NOM | MAX | UNIT |
|-----------------|----------------------------|------|-----|-----|------|
| V <sub>CC</sub> | Supply voltage             | 2.95 | 3.3 | 3.6 | V    |
| T <sub>A</sub>  | Operating lead temperature | -40  |     | 100 | °C   |
| $V_{IH}$        | CMOS input high voltage    | 2.1  |     |     | V    |
| $V_{IL}$        | CMOS input low voltage     |      |     | 0.7 | V    |

#### DC ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

|                 | PARAMETER        | TEST CONDITIONS   | MIN  | TYP | MAX | UNIT |
|-----------------|------------------|---|------|-----|-----|------|
| V <sub>CC</sub> | Supply voltage   |   | 2.95 | 3.3 | 3.6 | V    |
|                 | Cumply ourrant   | 600mV <sub>p-p</sub> SWG setting (CML output current included)          |      | 170 |     | A    |
| ICC             | Supply current   | 1200mV <sub>p-p</sub> SWG setting (CML output current included)         | 22   | 225 | 290 | mA   |
|                 | LOS high voltage | $I_{SOURCE}$ = 50μA; 10kΩ Pull-up to $V_{CC}$ on LOSA or LOSB pin       | 2.4  |     |     | V    |
|                 | LOS low voltage  | $I_{SINK}$ = 10mA; 10k $\Omega$ Pull-up to $V_{CC}$ on LOSA or LOSB pin | _    |     | 0.4 | V    |

# **AC ELECTRICAL CHARACTERISTICS**

Typical operating condition is at V<sub>CC</sub> = 3.3V and T<sub>A</sub> = 25°C. Over recommended operating conditions (unless otherwise noted)

|                     | PARAMETER                    | TEST CONDITIONS   | MIN  | TYP | MAX | UNIT       |
|---------------------|------------------------------|---|------|-----|-----|------------|
|                     | Low frequency -3dB bandwidth | With 0.1µF input AC-coupling capacitors   |      | 30  | 50  | kHz        |
| V <sub>IN,MIN</sub> | Data input sensitivity       | BER < 10 <sup>-12</sup> , K28.5 pattern at 11.3Gbps over a 10m 28AWG cable including two SMA connectors (27dB loss at 5.65GHz), SWG = 600mV <sub>p-p</sub> setting, no de-emphasis, maximum interconnect length setting. Voltage measured at the input of the cable.                            |      |     | 250 | $mV_{p-p}$ |
| V <sub>IN,MAX</sub> | Data input overload          | BER < $10^{-12}$ , K28.5 pattern at 11.3Gbps, K28.5 pattern at 11.3Gbps over a 15m 24AWG cable including two SMA connectors (29dB loss at 5.65GHz), SWG = $600\text{mV}_{\text{p-p}}$ setting, no de-emphasis, maximum interconnect length setting. Voltage measured at the input of the cable. | 1600 |     |     | $mV_{p-p}$ |

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<sup>(2)</sup> All voltage values are with respect to network ground terminal.

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# **AC ELECTRICAL CHARACTERISTICS (continued)**

Typical operating condition is at  $V_{CC} = 3.3V$  and  $T_A = 25^{\circ}C$ . Over recommended operating conditions (unless otherwise noted)

|                     | PARAMETER                              | TEST CONDITIONS   | MIN                   | TYP                   | MAX  | UNIT                 |
|---------------------|--|---|-----------------------|-----------------------|--|----------------------|
|                     |  | DIS = Low, SWG = Low, $V_{IN}$ = 400m $V_{p-p}$ , no de-emphasis, no interconnect loss.   | 150                   | 225                   | 350  |                      |
| $V_{OD}$            | Differential data output voltage swing | $\begin{split} DIS = Low, SWG = 600 mV_{p-p} \text{ setting, } V_{IN} = 400 mV_{p-p}, \\ no \text{ de-emphasis, no interconnect loss.} \end{split}$   | 400                   | 600                   | 800  | $mV_{p-p}$           |
|                     |  | DIS = Low, SWG = High, $V_{\rm IN}$ = 400m $V_{\rm p-p}$ , no de-emphasis, no interconnect loss.  | 800                   | 1200                  | 800<br>1600<br>V <sub>CC</sub> -0.04<br>V <sub>CC</sub> -0.12<br>V <sub>CC</sub> -0.25 |                      |
|                     |  | DIS = Low, SWG = Low, $V_{IN}$ = 400mV <sub>p-p</sub> , no de-emphasis, no interconnect loss, $50\Omega$ to VCC output termination.   | V <sub>CC</sub> -0.12 | V <sub>CC</sub> -0.08 | V <sub>CC</sub> -0.04  |                      |
| $V_{CM,OUT}$        | Data output common-mode voltage        | DIS = Low, SWG = $600 \text{mV}_{\text{p-p}}$ setting, $V_{\text{IN}} = 400 \text{mV}_{\text{p-p}}$ , no de-emphasis, no interconnect loss, $50\Omega$ to VCC output termination. $V_{\text{CC}}$ -0.29 $V_{\text{CC}}$ -0.205 $V_{\text{CC}}$  | V <sub>CC</sub> -0.12 | V                     |  |                      |
|                     |  | DIS = Low, SWG = High, $V_{IN}$ = $400mV_{p-p}$ , no de-emphasis, no interconnect loss, $50\Omega$ to VCC output termination.   | V <sub>CC</sub> -0.65 | V <sub>CC</sub> -0.45 | V <sub>CC</sub> -0.25  |                      |
| V <sub>CM,RIP</sub> | Common-mode output ripple              | DIS = Low, SWG = $600 \text{mV}_{\text{p-p}}$ setting, K28.5 pattern at 11.3Gbps, no interconnect loss, $600 \text{mV}$ on DE pin, $\text{V}_{\text{IN}}$ = $1600 \text{mV}_{\text{p-p}}$ .   |                       | 2                     | 5  | ${\sf mV}_{\sf RMS}$ |
| $V_{OD,RIP}$        | Differential output ripple             | DIS = High, K28.5 pattern at 11.3Gbps, no interconnect loss, $V_{\rm IN}$ = 1600m $V_{\rm p-p}$ .   |                       | 15                    | 20   | $mV_{p-p}$           |
| DE                  | Output de emphasis                     | K28.5 pattern at 11.3Gbps on both channels, no interconnect loss, $V_{\text{IN}} = 400 \text{mV}_{\text{p-p}}, \text{SWG} = 600 \text{mV}_{\text{p-p}} \text{ setting, no de-emphasis.}$  |                       | 0                     |  | 40                   |
| DE                  | Output de-emphasis                     | K28.5 pattern at 11.3Gbps on both channels, no interconnect loss, $V_{\text{IN}} = 400 \text{mV}_{\text{p-p}}, \text{SWG} = 600 \text{mV}_{\text{p-p}} \text{ setting, maximum de-emphasis level.}$   |                       | 7                     |  | dB                   |
| DJ                  | Deterministic jitter                   | K28.5 pattern at 11.3Gbps on both channels, 10m 28AWG cable (27dB loss at 5.65GHz), $V_{\text{IN}} = 400\text{mV}_{\text{p-p}}, \text{SWG} = 600\text{mV}_{\text{p-p}}, \text{setting, }600\text{mV on DE pin, maximum interconnect length setting.}$   |                       | 8                     | В  | ne                   |
| DJ                  | Deterministic julei                    | K28.5 pattern at 11.3Gbps on both channels, 15m 24AWG cable (29dB loss at 5.65GHz), $V_{\text{IN}} = 400\text{mV}_{\text{p-p}}, \text{SWG} = 600\text{mV}_{\text{p-p}} \text{ setting, } 600\text{mV on DE pin, maximum interconnect length setting.}$  |                       | 12                    |  | · ps <sub>p-p</sub>  |
| RJ                  | Random jitter                          | K28.5 pattern at 11.3Gbps on both channels, 10m 28AWG cable (27dB loss at 5.65GHz), $V_{\text{IN}} = 400\text{mV}_{\text{p-p}}, \text{SWG} = 600\text{mV}_{\text{p-p}} \text{ setting, } 600\text{mV on DE pin, maximum interconnect length setting.}$  |                       | 1.2                   |  | ne                   |
| NJ                  | Kandoni jidei                          | K28.5 pattern at 11.3Gbps on both channels, 15m 24AWG cable (29dB loss at 5.65GHz), $V_{\text{IN}} = 400\text{mV}_{\text{p-p}}, \text{SWG} = 600\text{mV}_{\text{p-p}}, \text{setting, 600mV on DE pin, maximum interconnect length setting.}$  |                       | 1.4                   |  | ps <sub>RMS</sub>    |
| JPXT                | Crosstalk jitter penalty               | Channel A: K28.5 pattern at 11.3Gbps, 15m 24AWG cable (29dB loss at 5.65GHz), $V_{IN} = 600 \text{mV}_{p\text{-}p}$ , Register 2 = 10h (offset cancellation OFF), Register 3 = 01h (equalizer filter 1 OFF), Register 4 = 66h (680mVpp output swing, 3.3dB output de-emphasis); Channel B: Repeated 1010 pattern at 11.3Gbps, no interconnect line loss, $V_{IN} = 600 \text{mV}_{p\text{-}p}$ , Register 6 = 10h (offset cancellation OFF), Register 7 = 0Fh (all equalizer filters OFF), Register 8 = F6h (680mVpp output swing, 7dB output de-emphasis); |                       |                       | 3  | ps <sub>p-p</sub>    |
| t <sub>R</sub>      | Output rise time                       | 20% to 80%, No interconnect line, $V_{IN} = 400 m V_{p-p}$ , SWG = $600 m V_{p-p}$ setting, no de-emphasis  |                       | 28                    |  | ne                   |
| t <sub>F</sub>      | Output fall time                       | 20% to 80%, no interconnect loss, $V_{IN} = 400 \text{mV}_{\text{p-p}}$ , SWG = $600 \text{mV}_{\text{p-p}}$ setting, no de-emphasis  |                       | 28                    |  | ps                   |

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# **AC ELECTRICAL CHARACTERISTICS (continued)**

Typical operating condition is at  $V_{CC} = 3.3V$  and  $T_A = 25^{\circ}C$ . Over recommended operating conditions (unless otherwise noted)

|                      | PARAMETER                            | TEST CONDITIONS  | MIN  | TYP     | MAX                | UNIT              |
|----------------------|--------------------------------------|--|------|---------|--------------------|-------------------|
| 00044                | D'''                                 | 0.01GHz < f < 4.1GHz   |      | See (1) |                    | ID.               |
| SDD11                | Differential input return loss       | 4.1GHz < f < 12.1GHz   |      | See (2) |                    | dB                |
| 00000                | D'''                                 | 0.01GHz < f < 4.1GHz   |      | See (1) |                    |                   |
| SDD22                | Differential output return loss      | 4.1GHz < f < 12.1GHz   |      | See (2) | 300<br>500<br>4/30 | dB                |
| 00000                | 0                                    | 0.01GHz < f < 7.5GHz   |      | See (3) |                    | ı.                |
| SCC22                | Common-mode output return loss       | 7.5GHz < f < 12.1GHz   |      | See (4) |                    | dB                |
| V                    | LOC accept the calculation to a      | K28.5 Pattern at 11.3Gbps, no interconnect loss,<br>LOSL = Open (also applies to Pin Control Mode 2)   | 45   | 90      |                    | >/                |
| V <sub>AS</sub>      | LOS assert threshold voltage         | K28.5 Pattern at 11.3Gbps, no interconnect loss, V(LOSL) = 0.7V  | 70   | 140     |                    | mV <sub>p-p</sub> |
| V                    | LOC do account threadhold voltage    | K28.5 Pattern at 11.3Gbps, no interconnect loss,<br>LOSL = Open (also applies to Pin Control Mode 2)   |      | 150     | 300                | \/                |
| V <sub>DAS</sub>     | LOS de-assert threshold voltage      | K28.5 Pattern at 11.3Gbps, no interconnect, V(LOSL) = 0.7V   |      | 235     | 500                | mV <sub>p-p</sub> |
|                      | LOS hysteresis                       | 20log(V <sub>DAS</sub> / V <sub>AS</sub> )   | 2.5  | 4.0     |                    | dB                |
| T <sub>AS/DAS</sub>  | LOS assert/De-assert time            |  | 1/10 | 2/20    | 4/30               | μs                |
| $V_{FAS}$            | Fast LOS assert threshold voltage    | K28.5 Pattern at 11.3Gbps, no interconnect loss, Reg 5/9 = 101111111b  |      | 150     |                    | $mV_{p\text{-}p}$ |
| V <sub>FDAS</sub>    | Fast LOS de-assert threshold voltage | K28.5 Pattern at 11.3Gbps, no interconnect loss,<br>Reg 5/9 = 101111111b   |      | 220     |                    | mV <sub>p-p</sub> |
|                      | Fast LOS hysteresis                  | 20log(V <sub>FDAS</sub> / V <sub>FAS</sub> )   |      | 3.3     |                    | dB                |
| T <sub>SQUELCH</sub> | Squelch time                         | Fast auto-squelch mode, no interconnect loss, $600 mV_{p-p}$ input swing, K28.5 pattern, 1.5Gbps, SWG = $600 mV_{p-p}$ setting. Time from input off to output voltage < $120 mV_{p-p}$ |      | 5       |                    | ns                |
| T <sub>DIS</sub>     | Disable response time                |  |      | 2       |                    | ns                |
| T <sub>SKEW</sub>    | Channel-to-channel skew              | OUTB+/ OUTB- relative to OUTA+/OUTA-   |      | 2       |                    | ps                |
|                      | Latency                              | from IN[B:A]+/ IN[B:A]- to OUT[B:A]+/OUT[B:A]-   |      | 165     |                    | ps                |

Differential return loss given by SDD11, SDD22 =  $12.3 - 13 \log_{10}(f/5.5)$ , f in GHz

<sup>(2)</sup> 

Differential return loss given by SDD11, SDD22 = 18 - 2 √f, f in GHz
Common-mode output return loss given by SCC22 = 12 - 2.8f, f in GHz
Common-mode output return loss given by SCC22 = 5.2 - 0.08f, f in GHz



#### TWO-WIRE SERIAL INTERFACE AND CONTROL LOGIC

#### **FUNCTIONAL DESCRIPTION**

The TLK1102E uses a two-wire serial interface for digital control. The two circuit inputs, SDA and SCL, are driven respectively by the serial data and serial clock from a microcontroller, for example. Both inputs require  $10k\Omega$  pull-up resistors to VCC when used. For driving these inputs, an open-drain output is recommended.

The two-wire interface allows write access to the internal memory map to modify control registers and read access to read out control and status signals. The TLK1102E is a slave device only which means that it cannot initiate a transmission itself; it always relies on the availability of the clock (SCL) signal for the duration of the transmission. The master device provides the clock signal as well as the START and STOP commands. The protocol for a data transmission is as follows:

- 1. START command
- 2. 7-bit slave address (0101A<sub>2</sub> $\overline{A}_1\overline{A}_0$ ) followed by an eighth bit which is the data direction bit (R/W). A zero indicates a WRITE and a 1 indicates a READ. The default slave address is 0101100. The A<sub>2</sub>, $\overline{A}_1$ , and  $\overline{A}_0$  address bits change with the status of the ADD2, ADD1, and ADD0 device pins, respectively. Those pins are internally pulled up. Pulling down the ADD[2:0] pins changes the address to 0101011. Table 2 summarizes the slave address settings:
- 3. 8-bit register address
- 4. 8-bit register data word
- 5. STOP command

ADDR0 ADD2 ADDR1 SLAVE ADDRESS 0101011 0 0 0 0 0 1 0101010 0 0 1 0101001 0 1 1 0101000 1 0 0 0101111 1 0 1 0101110 1 1 0 0101101 1 1 1 0101100

**Table 2. Slave Address Settings** 

Regarding timing, the TLK1102E is  $I^2$ C-compatible. The typical timing is shown in Figure 3 and a complete data transfer is shown in Figure 4. Parameters for Figure 3 are defined in Table 3.

Bus Idle: Both SDA and SCL lines remain HIGH

**Start Data Transfer**: A change in the state of the SDA line, from HIGH to LOW, while the SCL line is HIGH, defines a START condition (S). Each data transfer is initiated with a START condition.

**Stop Data Transfer:** A change in the state of the SDA line from LOW to HIGH while the SCL line is HIGH defines a STOP condition (P). Each data transfer is terminated with a STOP condition; however, if the master still wishes to communicate on the bus, it can generate a repeated START condition and address another slave without first generating a STOP condition.

**Data Transfer:** The number of data bytes transferred between a START and a STOP condition is not limited and is determined by the master device. The receiver acknowledges the transfer of data.

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**Acknowledge:** Each receiving device, when addressed, is obliged to generate an acknowledge bit. The transmitter releases the SDA line and a device that acknowledges must pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is stable LOW during the HIGH period of the acknowledge clock pulse. Setup and hold times must be taken into account. When a slave-receiver does not acknowledge the slave address, the data line must be left HIGH by the slave. The master can then generate a STOP condition to abort the transfer. If the slave-receiver does acknowledge the slave address but some time later in the transfer cannot receive any more data bytes, the master must abort the transfer. This is indicated by the slave generating the not acknowledge on the first byte to follow. The slave leaves the data line HIGH and the master generates the STOP condition.

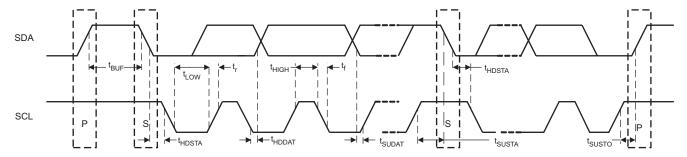


Figure 3. Two-Wire Serial Interface Timing Diagram.

| SYMBOL             | PARAMETER   | MIN | MAX | UNIT |
|--------------------|---|-----|-----|------|
| f <sub>SCL</sub>   | SCL Clock frequency   |     | 400 | kHz  |
| t <sub>BUF</sub>   | Bus free time between START and STOP conditions   | 1.3 |     | μs   |
| t <sub>HDSTA</sub> | Hold time after repeated START condition. After this period, the first clock pulse is generated | 0.6 |     | μs   |
| t <sub>LOW</sub>   | Low period of the SCL clock   | 1.3 |     | μs   |
| t <sub>HIGH</sub>  | High period of the SCL clock  | 0.6 |     | μs   |
| t <sub>SUSTA</sub> | Setup time for a repeated START condition   | 0.6 |     | μs   |
| t <sub>HDDAT</sub> | Data HOLD time  | 0   |     | μs   |
| t <sub>SUDAT</sub> | Data setup time   | 100 |     | ns   |
| t <sub>R</sub>     | Rise time of both SDA and SCL signals   |     | 300 | ns   |
| t <sub>F</sub>     | Fall time of both SDA and SCL signals   |     | 300 | ns   |
| t <sub>SUSTO</sub> | Setup time for STOP condition   | 0.6 |     | μs   |

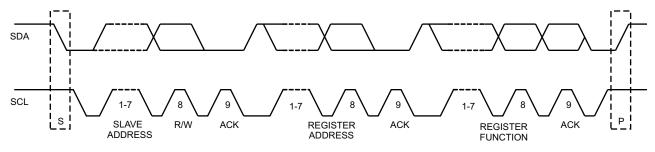


Figure 4. Two-Wire Serial Interface Data Transfer

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#### **REGISTER MAPPING**

The register mapping for read/write register addresses 0 (0x00) through 15 (0x0F) are shown in Table 4 to Table 19. Table 20 describes the circuit functionality based on the register settings.

#### Table 4. Register 0x00 - General Device Settings

| REGISTER ADDRESS 0x00                           |         |          |          |          |          |        |           |  |  |
|---|---------|----------|----------|----------|----------|--------|-----------|--|--|
| BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |         |          |          |          |          |        |           |  |  |
| RESET   | PWRDOWN | Reserved | Reserved | Reserved | Reserved | LOSRNG | CHA_TRACK |  |  |

#### Table 5. Register 0x01 - Reserved

|   | REGISTER ADDRESS 0x01 |          |          |  |  |  |  |  |  |  |  |  |
|---|-----------------------|----------|----------|--|--|--|--|--|--|--|--|--|
| BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |                       |          |          |  |  |  |  |  |  |  |  |  |
| Reserved  | Reserved              | Reserved | Reserved | Reserved Reserved Reserved Reserved Reserved Reserved Reserved |  |  |  |  |  |  |  |  |

## Table 6. Register 0x02 - Control A Control Settings

|       | REGISTER ADDRESS 0x02 |        |       |          |         |       |         |  |  |  |
|-------|-----------------------|--------|-------|----------|---------|-------|---------|--|--|--|
| BIT 7 | BIT 6                 | BIT 5  | BIT 4 | BIT 3    | BIT 2   | BIT 1 | BIT 0   |  |  |  |
| INOFF | OUTOFF                | LOSOFF | OCOFF | Reserved | SQUELCH | POL   | DISABLE |  |  |  |

## Table 7. Register 0x03 - Control A Input Settings

|   | REGISTER ADDRESS 0x03           |  |  |  |  |  |  |  |  |  |
|---|---------------------------------|--|--|--|--|--|--|--|--|--|
| BIT 7         BIT 6         BIT 5         BIT 4         BIT 3         BIT 2         BIT 1         BIT 0 |                                 |  |  |  |  |  |  |  |  |  |
| BW3   | BW3 BW2 BW1 BW0 EQ3 EQ2 EQ1 EQ0 |  |  |  |  |  |  |  |  |  |

# Table 8. Register 0x04 - Channel A Output Settings

|   | REGISTER ADDRESS 0x04 |       |       |      |      |      |      |  |  |  |  |
|---|-----------------------|-------|-------|------|------|------|------|--|--|--|--|
| BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |                       |       |       |      |      |      |      |  |  |  |  |
| DEEM3   | DEEM2                 | DEEM1 | DEEM0 | AMP3 | AMP2 | AMP1 | AMP0 |  |  |  |  |

# Table 9. Register 0x05 - Channel A LOS Settings

|   | REGISTER ADDRESS 0x05 |         |         |         |         |         |         |  |  |  |  |
|---|-----------------------|---------|---------|---------|---------|---------|---------|--|--|--|--|
| BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |                       |         |         |         |         |         |         |  |  |  |  |
| FAST  | LOSLVL6               | LOSLVL5 | LOSLVL4 | LOSLVL3 | LOSLVL2 | LOSLVL1 | LOSLVL0 |  |  |  |  |

#### Table 10. Register 0x06 - Channel B Control Settings

| REGISTER ADDRESS 0x06 |        |        |       |          |         |       |         |  |  |  |
|-----------------------|--------|--------|-------|----------|---------|-------|---------|--|--|--|
| BIT 7                 | BIT 6  | BIT 5  | BIT 4 | BIT 3    | BIT 2   | BIT 1 | BIT 0   |  |  |  |
| INOFF                 | OUTOFF | LOSOFF | OCOFF | Reserved | SQUELCH | POL   | DISABLE |  |  |  |

## Table 11. Register 0x07 - Channel B Input Settings

|   | REGISTER ADDRESS 0x07 |     |     |     |     |     |     |  |  |  |  |
|---|-----------------------|-----|-----|-----|-----|-----|-----|--|--|--|--|
| BIT 7         BIT 6         BIT 5         BIT 4         BIT 3         BIT 2         BIT 1         BIT 0 |                       |     |     |     |     |     |     |  |  |  |  |
| BW3   | BW2                   | BW1 | BW0 | EQ3 | EQ2 | EQ1 | EQ0 |  |  |  |  |

## Table 12. Register 0x08 - Channel B Output Settings

|       | REGISTER ADDRESS 0x08 |       |       |       |       |       |       |  |  |  |
|-------|-----------------------|-------|-------|-------|-------|-------|-------|--|--|--|
| BIT 7 | BIT 6                 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |  |  |  |
| DEEM3 | DEEM2                 | DEEM1 | DEEM0 | AMP3  | AMP2  | AMP1  | AMP0  |  |  |  |

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# Table 13. Register 0x09 - Channel B LOS Settings

|   | REGISTER ADDRESS 0x09 |         |         |         |         |         |         |  |  |  |
|---|-----------------------|---------|---------|---------|---------|---------|---------|--|--|--|
| BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |                       |         |         |         |         |         |         |  |  |  |
| FAST  | LOSLVL6               | LOSLVL5 | LOSLVL4 | LOSLVL3 | LOSLVL2 | LOSLVL1 | LOSLVL0 |  |  |  |

# Table 14. Register 0x0A - Reserved

| REGISTER ADDRESS 0x0A                           |          |          |          |          |          |          |          |  |  |
|---|----------|----------|----------|----------|----------|----------|----------|--|--|
| BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |          |          |          |          |          |          |          |  |  |
| Reserved  | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |  |  |

# Table 15. Register 0x0B - Reserved

| REGISTER ADDRESS 0x0B |   |          |          |          |          |          |          |  |  |  |
|-----------------------|---|----------|----------|----------|----------|----------|----------|--|--|--|
| BIT 7                 | 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |          |          |          |          |          |          |  |  |  |
| Reserved              | Reserved                                    | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |  |  |  |

## Table 16. Register 0x0C - Reserved

|          | REGISTER ADDRESS 0x0C                           |          |          |          |          |          |          |  |  |  |
|----------|---|----------|----------|----------|----------|----------|----------|--|--|--|
| BIT 7    | BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |          |          |          |          |          |          |  |  |  |
| Reserved | Reserved  | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |  |  |  |

# Table 17. Register 0x0D - Reserved

|          | REGISTER ADDRESS 0x0D                           |          |          |          |          |          |          |  |  |  |
|----------|---|----------|----------|----------|----------|----------|----------|--|--|--|
| BIT 7    | BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |          |          |          |          |          |          |  |  |  |
| Reserved | Reserved  | Reserved | Reserved | Reserved | Reserved | Reserved | Reserved |  |  |  |

# Table 18. Register 0x0E – Device Status

|          | REGISTER ADDRESS 0x0E                           |          |          |          |          |         |         |  |  |  |
|----------|---|----------|----------|----------|----------|---------|---------|--|--|--|
| BIT 7    | BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |          |          |          |          |         |         |  |  |  |
| Reserved | Reserved  | Reserved | Reserved | Reserved | Reserved | LOS_CHB | LOS_CHA |  |  |  |

## Table 19. Register 0x0F - Reserved

|          | REGISTER ADDRESS 0x0F                           |          |          |          |          |  |  |  |  |  |
|----------|---|----------|----------|----------|----------|--|--|--|--|--|
| BIT 7    | BIT 7 BIT 6 BIT 5 BIT 4 BIT 3 BIT 2 BIT 1 BIT 0 |          |          |          |          |  |  |  |  |  |
| Reserved | Reserved  | Reserved | Reserved | Reserved | Reserved |  |  |  |  |  |

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# Table 20. Register Functionality

| REGISTER | BIT(s) | NAME      | DESCRIPTION                                  | FUNCTION   | DEFAULT  |
|----------|--------|-----------|--|--|----------|
| 0        | 7      | RESET     | Software Reset                               | Resets all registers   | 00000000 |
|          | 6      | PWRDOWN   | Powerdown                                    | Set high to power down the device. In powerdown mode the the current consumption about 2.5mA |          |
|          | 5 - 2  | Reserved  |  |  |          |
|          | 1      | LOSRNG    | LOS Range Select                             | Set to high to increase LOS detection sensitivity  |          |
|          | 0      | CHA_TRACK | Channel A Tracking<br>Mode                   | All settings from channel A will be used for both channels, A and B                          |          |
| 1        | 7      | Reserved  |  |  | 00000000 |
|          | 6      | Reserved  |  |  |          |
|          | 5      | Reserved  |  |  |          |
|          | 4      | Reserved  |  |  |          |
|          | 3      | Reserved  |  |  |          |
|          | 2      | Reserved  |  |  |          |
|          | 1      | Reserved  |  |  |          |
|          | 0      | Reserved  |  |  |          |
| 2        | 7      | INOFF     | Channel A Input Off                          | Set high to power down channel A input stages  | 00000000 |
|          | 6      | OUTOFF    | Channel A Output Off                         | Set high to power down channel A output driver and buffer                                    |          |
|          | 5      | LOSOFF    | Channel A LOS<br>Detector Off                | Set high to power down channel A input signal detector                                       |          |
|          | 4      | OCOFF     | Channel A Offset<br>Cancellation Off         | Disables channel A offset cancellation circuit   |          |
|          | 3      | Reserved  |  |  |          |
|          | 2      | SQUELCH   | Channel A Squelch<br>Mode                    | High activates channel A internal output squelch function                                    |          |
|          | 1      | POL       | Channel A Polarity<br>Switch                 | Set to high to change polarity of channel A output signal                                    |          |
|          | 0      | DISABLE   | Channel A Output Disable                     | Set to high to disable channel A output data and keep common mode level                      |          |
| 3        | 7      | BW3       | Channel A Bandwidth<br>Select 3 (MSB)        | 0000 -> highest bandwidth<br>1111 -> lowest bandwidth  | 00000000 |
|          | 6      | BW2       | Channel A Bandwidth<br>Select 2              |  |          |
|          | 5      | BW1       | Channel A Bandwidth<br>Select 1              |  |          |
|          | 4      | BW0       | Channel A Bandwidth<br>Select 0 (LSB)        |  |          |
|          | 3      | EQ3       | Channel A EQ Filter<br>Stage 3 Control (MSB) | Set to high to switch off channel A EQ filter 3  |          |
|          | 2      | EQ2       | Channel A EQ Filter<br>Stage 2 Control       | Set to high to switch off channel A EQ filter 2  |          |
|          | 1      | EQ1       | Channel A EQ Filter<br>Stage 1 Control       | Set to high to switch off channel A EQ filter 1  |          |
|          | 0      | EQ0       | Channel A EQ Filter<br>Stage 0 Control (LSB) | Set to high to switch off channel A EQ filter 0  |          |



| REGISTER | BIT(s) | NAME     | DESCRIPTION                                 | FUNCTION  | DEFAULT  |  |
|----------|--------|----------|---|---|----------|--|
| 4        | 7      | DEEM3    | Channel A Output<br>De-emphasis 3 (MSB)     | 0000 -> no peaking<br>1111 -> highest peaking   | 00000000 |  |
|          | 6      | DEEM2    | Channel A Output<br>De-emphasis 2           |   |          |  |
|          | 5      | DEEM1    | Channel A Output<br>De-emphasis 1           |   |          |  |
|          | 4      | DEEM0    | Channel A Output<br>De-emphasis 0 (LSB)     |   |          |  |
|          | 3      | AMP3     | Channel A Output<br>Amplitude 3 (MSB)       | 0000 -> 225mV <sub>p-p</sub><br>1111-> 1200mV <sub>p-p</sub>  |          |  |
|          | 2      | AMP2     | Channel A Output<br>Amplitude               | approximately 60mV <sub>p-p</sub> per step  |          |  |
|          | 1      | AMP1     | Channel A Output<br>Amplitude 1             |   |          |  |
|          | 0      | AMP0     | Channel A Output<br>Amplitude 0 (LSB)       |   |          |  |
| 5        | 7      | FAST     | Channel A Fast Signal Detection Mode        | Set to high to select fast signal detection mode on channel A   | 00000000 |  |
|          | 6      | LOSLVL6  | Channel A LOS<br>Threshold Level 6<br>(MSB) | 0000000 -> Minimum LOS assert level<br>1001100 -> Maximum LOS assert level<br>Settings out of the above range are not supported |          |  |
|          | 5      | LOSLVL5  | Channel A LOS<br>Threshold Level 5          |   |          |  |
|          | 4      | LOSLVL4  | Channel A LOS<br>Threshold Level 4          |   |          |  |
|          | 3      | LOSLVL3  | Channel A LOS<br>Threshold Level 3          |   |          |  |
|          | 2      | LOSLVL2  | Channel A LOS<br>Threshold Level 2          |   |          |  |
|          | 1      | LOSLVL1  | Channel A LOS<br>Threshold Level 1          |   |          |  |
|          | 0      | LOSLVL0  | Channel A LOS<br>Threshold Level 0<br>(LSB) |   |          |  |
| 6        | 7      | INOFF    | Channel B Input Off                         | Set high to power down channel B input stages   | 00000000 |  |
|          | 6      | OUTOFF   | Channel B Output Off                        | Set high to power down channel B output driver and buffer   |          |  |
|          | 5      | LOSOFF   | Channel B LOS<br>Detector Off               | Set high to power down channel B input signal detector  |          |  |
|          | 4      | OCOFF    | Channel B Offset<br>Cancellation Off        | Disables channel B offset cancellation circuit  |          |  |
|          | 3      | Reserved |   |   |          |  |
|          | 2      | SQUELCH  | Channel B Squelch<br>Mode                   | High activates channel B internal output squelch function   |          |  |
|          | 1      | POL      | Channel B Polarity<br>Switch                | Set to high to change polarity of channel B output signal   |          |  |
|          | 0      | DISABLE  | Channel B Output<br>Disable                 | Set to high to disable channel B output data and keep common mode level   |          |  |

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| REGISTER | BIT(s) | NAME    | DESCRIPTION                                  | FUNCTION   | DEFAULT  |
|----------|--------|---------|--|--|----------|
| 7        | 7      | BW3     | Channel B Bandwidth<br>Select 3 (MSB)        | 0000 -> highest bandwidth<br>1111 -> lowest bandwidth  | 00000000 |
|          | 6      | BW2     | Channel B Bandwidth<br>Select 2              |  |          |
|          | 5      | BW1     | Channel B Bandwidth<br>Select 1              |  |          |
|          | 4      | BW0     | Channel B Bandwidth<br>Select 0 (LSB)        |  |          |
|          | 3      | EQ3     | Channel B EQ Filter<br>Stage 3 Control (MSB) | Set to high to switch off channel B EQ filter 3  |          |
|          | 2      | EQ2     | Channel B EQ Filter<br>Stage 2 Control       | Set to high to switch off channel B EQ filter 2  |          |
|          | 1      | EQ1     | Channel B EQ Filter<br>Stage 1 Control       | Set to high to switch off channel B EQ filter 1  |          |
|          | 0      | EQ0     | Channel B EQ Filter<br>Stage 0 Control (LSB) | Set to high to switch off channel B EQ filter 0  |          |
| 8        | 7      | DEEM3   | Channel B Output<br>De-emphasis 3 (MSB)      | 0000 -> no peaking<br>1111 -> highest peaking  | 00000000 |
|          | 6      | DEEM2   | Channel B Output<br>De-emphasis 2            |  |          |
|          | 5      | DEEM1   | Channel B Output<br>De-emphasis 1            |  |          |
|          | 4      | DEEM0   | Channel B Output<br>De-emphasis 0 (LSB)      |  |          |
|          | 3      | AMP3    | Channel B Output<br>Amplitude 3 (MSB)        | 0000 -> 225mV <sub>p-p</sub><br>1111-> 1200mV <sub>p-p</sub>   |          |
|          | 2      | AMP2    | Channel B Output<br>Amplitude                | approximately 60mV <sub>p-p</sub> per step   |          |
|          | 1      | AMP1    | Channel B Output<br>Amplitude 1              |  |          |
|          | 0      | AMP0    | Channel B Output<br>Amplitude 0 (LSB)        |  |          |
| 9        | 7      | FAST    | Channel B Fast Signal<br>Detection Mode      | Set to high to select fast signal detection mode on channel B  | 00000000 |
|          | 6      | LOSLVL6 | Channel B LOS<br>Threshold Level 6<br>(MSB)  | 0000000 = Minimum LOS assert level<br>1001100 = Maximum LOS assert level<br>Settings outside the above range are not supported |          |
|          | 5      | LOSLVL5 | Channel B LOS<br>Threshold Level 5           |  |          |
|          | 4      | LOSLVL4 | Channel B LOS<br>Threshold Level 4           |  |          |
|          | 3      | LOSLVL3 | Channel B LOS<br>Threshold Level 3           |  |          |
|          | 2      | LOSLVL2 | Channel B LOS<br>Threshold Level 2           |  |          |
|          | 1      | LOSLVL1 | Channel B LOS<br>Threshold Level 1           |  |          |
|          | 0      | LOSLVL0 | Channel B LOS<br>Threshold Level 0<br>(LSB)  |  |          |



| REGISTER | BIT(s) | NAME     | DESCRIPTION   | FUNCTION                         | DEFAULT  |
|----------|--------|----------|---------------|----------------------------------|----------|
| 10       | 7      | Reserved |               |                                  | 00000000 |
|          | 6      | Reserved |               |                                  |          |
|          | 5      | Reserved |               |                                  |          |
|          | 4      | Reserved |               |                                  |          |
|          | 3      | Reserved |               |                                  |          |
|          | 2      | Reserved |               |                                  |          |
|          | 1      | Reserved |               |                                  |          |
|          | 0      | Reserved |               |                                  |          |
| 11       | 7      | Reserved |               |                                  | 00000000 |
|          | 6      | Reserved |               |                                  |          |
|          | 5      | Reserved |               |                                  |          |
|          | 4      | Reserved |               |                                  |          |
|          | 3      | Reserved |               |                                  |          |
|          | 2      | Reserved |               |                                  |          |
|          | 1      | Reserved |               |                                  |          |
|          | 0      | Reserved |               |                                  |          |
| 12       | 7      | Reserved |               |                                  | 00000000 |
|          | 6      | Reserved |               |                                  |          |
|          | 5      | Reserved |               |                                  |          |
|          | 4      | Reserved |               |                                  |          |
|          | 3      | Reserved |               |                                  |          |
|          | 2      | Reserved |               |                                  |          |
|          | 1      | Reserved |               |                                  |          |
|          | 0      | Reserved |               |                                  |          |
| 13       | 7      | Reserved |               |                                  | 00000000 |
|          | 6      | Reserved |               |                                  |          |
|          | 5      | Reserved |               |                                  |          |
|          | 4      | Reserved |               |                                  |          |
|          | 3      | Reserved |               |                                  |          |
|          | 2      | Reserved |               |                                  |          |
|          | 1      | Reserved |               |                                  |          |
|          | 0      | Reserved |               |                                  |          |
| 14       | 7      | Reserved |               |                                  | 0000000  |
|          | 6      | Reserved |               |                                  |          |
|          | 5      | Reserved |               |                                  |          |
|          | 4      | Reserved |               |                                  |          |
|          | 3      | Reserved |               |                                  |          |
|          | 2      | Reserved |               |                                  |          |
|          | 1      | LOS_CHB  | LOS Channel B | Indicates LOS at input channel B |          |
|          | 0      | LOS_CHA  | LOS Channel A | Indicates LOS at input channel A |          |

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| REGISTER | BIT(s) | NAME     | DESCRIPTION | FUNCTION | DEFAULT  |
|----------|--------|----------|-------------|----------|----------|
| 15       | 7      | Reserved |             |          | 00000000 |
|          | 6      | Reserved |             |          |          |
|          | 5      | Reserved |             |          |          |
|          | 4      | Reserved |             |          |          |
|          | 3      | Reserved |             |          |          |
|          | 2      | Reserved |             |          |          |
|          | 1      | Reserved |             |          |          |
|          | 0      | Reserved |             |          |          |

#### TYPICAL CHARACTERISTICS

Typical operating condition is at  $V_{CC} = 3.3V$  and  $T_A = 25^{\circ}C$ ,  $V_{IN} = 400 \text{mV}_{p-p}$  (signal generator output), output swing =  $600 \text{mV}_{p-p}$  setting, no interconnect line at the output, and with default device settings (unless otherwise noted). Optimum input equalization level and output de-emphasis settings were used for the cable and backplane measurements. Differential S-parameter characteristics of Spectra-Strip® SKEWCLEAR® EXD twinaxial cables and a 40-inch N4000-13 SI<sup>TM</sup> backplane link with Amphenol XCede® backplane connectors used for the measurements captured in this document are as shown in Figure 5.

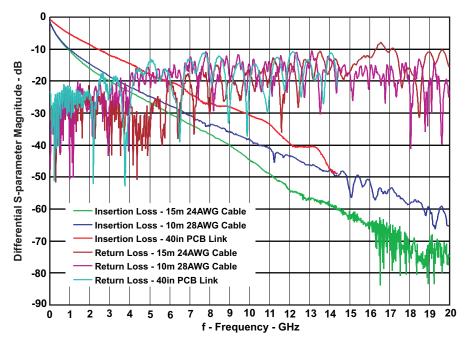


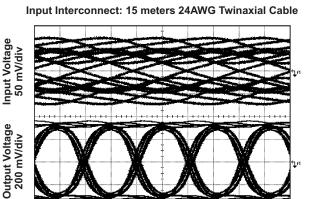
Figure 5. Typical Differential S-Parameter Characteristics of Twinaxial Cable and PCB Interconnect Lines

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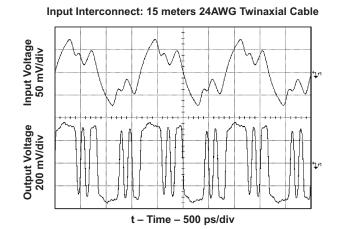
# INSTRUMENTS

# **TYPICAL CHARACTERISTICS (continued)**

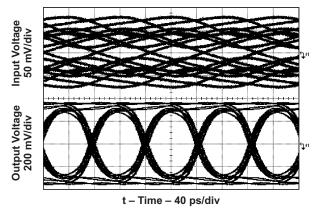
# DIFFERENTIAL EQUALIZER INPUT SIGNAL (TOP) AND OUTPUT SIGNAL (BOTTOM) AT 12Gbps USING A K28.5 PATTERN



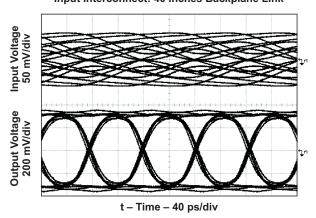
t - Time - 40 ps/div



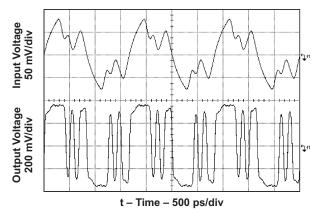
Input Interconnect: 10 meters 28AWG Twinaxial Cable



Input Interconnect: 40 inches Backplane Link



Input Interconnect: 10 meters 28AWG Twinaxial Cable



Input Interconnect: 40 inches Backplane Link

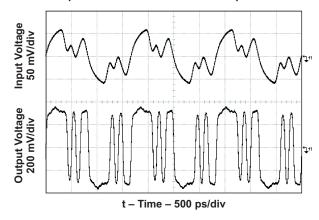
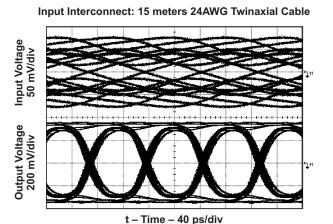


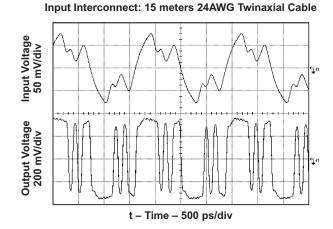
Figure 6. Equalizer Input and Output Signals with Different Interconnect Lines at 12Gbps

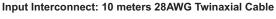
Product Folder Link(s): TLK1102E

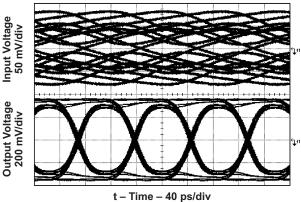
# **TYPICAL CHARACTERISTICS (continued)**

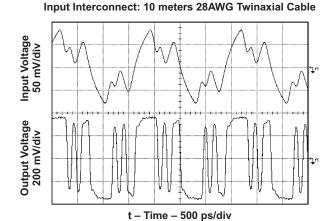
# DIFFERENTIAL EQUALIZER INPUT SIGNAL (TOP) AND OUTPUT SIGNAL (BOTTOM) AT 11.3Gbps USING A K28.5 PATTERN



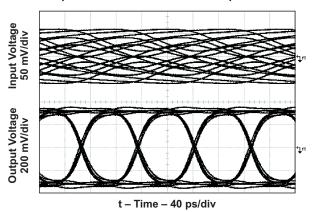


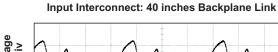






#### Input Interconnect: 40 inches Backplane Link





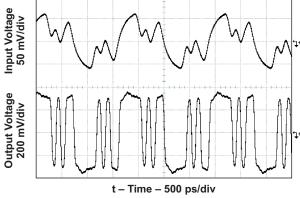


Figure 7. Equalizer Input and Output Signals with Different Interconnect Lines at 11.3Gbps

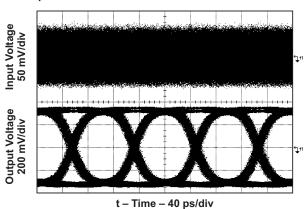
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# TEXAS INSTRUMENTS

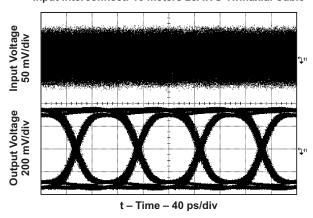
# **TYPICAL CHARACTERISTICS (continued)**

# DIFFERENTIAL EQUALIZER INPUT SIGNAL (TOP) AND OUTPUT SIGNAL (BOTTOM) AT 10.3125Gbps USING A PRBS $2^{31}$ -1 PATTERN





#### Input Interconnect: 10 meters 28AWG Twinaxial Cable



#### Input Interconnect: 40 inches Backplane Link

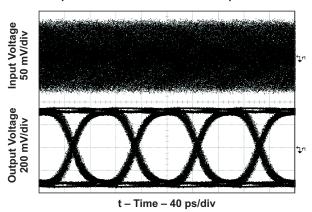


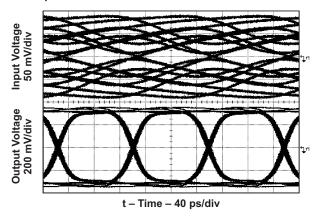
Figure 8. Equalizer Input and Output Signals with Different Interconnect Lines at 10.3125Gbps.

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# **TYPICAL CHARACTERISTICS (continued)**

# DIFFERENTIAL EQUALIZER INPUT SIGNAL (TOP) AND OUTPUT SIGNAL (BOTTOM) AT 8.5Gbps USING A K28.5 PATTERN

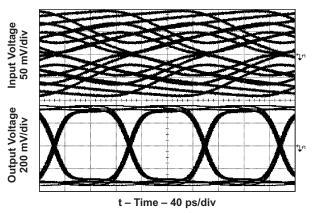


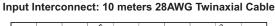


# Output Voltage 200 mV/div 50 mV/div

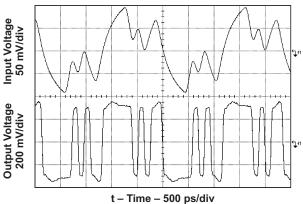
Input Interconnect: 15 meters 24AWG Twinaxial Cable

Input Interconnect: 10 meters 28AWG Twinaxial Cable

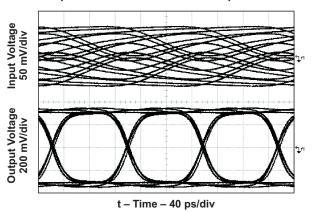




t - Time - 500 ps/div



Input Interconnect: 40 inches Backplane Link



Input Interconnect: 40 inches Backplane Link

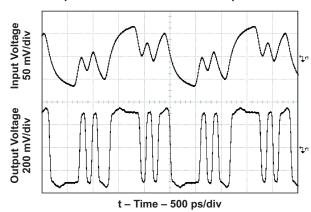


Figure 9. Equalizer Input and Output Signals with Different Interconnect Lines at 8.5Gbps.

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# TYPICAL CHARACTERISTICS (continued)

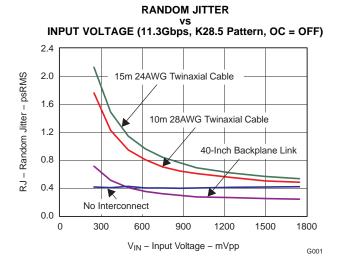
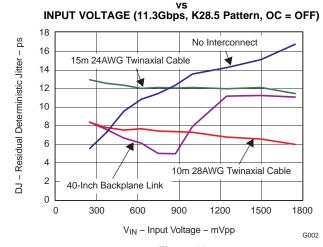


Figure 10.



RESIDUAL DETERMINISTIC JITTER

**NSTRUMENTS** 

Figure 11.



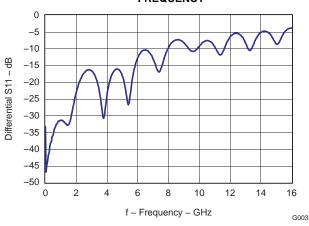


Figure 12.

# **DIFFERENTIAL OUTPUT RETURN LOSS** vs FREQUENCY

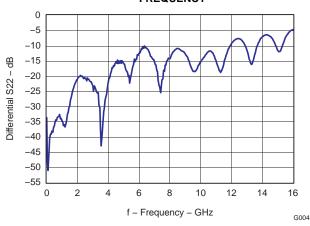


Figure 13.

# **REGISTER 5/9 SETTING/LOSL PIN VOLTAGE** vs LOS THRESHOLD VOLTAGE

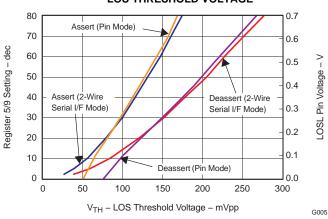


Figure 14.

# **REGISTER 5/9 SETTING/LOSL PIN VOLTAGE** vs LOS HYSTERESIS

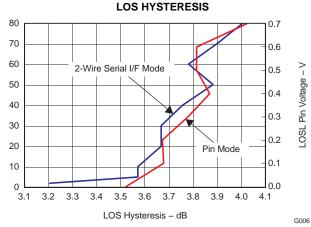


Figure 15.

LOSL Pin Voltage - V

Register 5/9 Setting

# **TYPICAL CHARACTERISTICS (continued)**

#### LOS THRESHOLD VOLTAGE/LOS HYSTERESIS VS DATA RATE (V(LOSL)=700mV) 8.5 300 V<sub>TH</sub> - LOS Threshold Voltage - mVpp 250 7.5 Deassert 200 Assert 150 5.5 100 Hysteresis 50 3.5 0 2.5 2 12 0 10 14 Data Rate - GHz

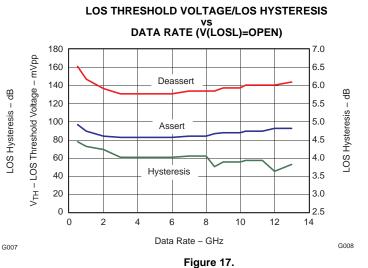


Figure 16.

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#### PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|---------------------|--------------|----------------------|---------|
| TLK1102ERGER     | ACTIVE | VQFN         | RGE                | 24   | 3000           | RoHS & Green | NIPDAUAG                      | Level-2-260C-1 YEAR | -40 to 100   | TLK<br>1102E         | Samples |
| TLK1102ERGET     | ACTIVE | VQFN         | RGE                | 24   | 250            | RoHS & Green | NIPDAUAG                      | Level-2-260C-1 YEAR | -40 to 100   | TLK<br>1102E         | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE OPTION ADDENDUM**

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# **PACKAGE MATERIALS INFORMATION**

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## TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device       | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TLK1102ERGER | VQFN            | RGE                | 24 | 3000 | 330.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |
| TLK1102ERGET | VQFN            | RGE                | 24 | 250  | 180.0                    | 12.4                     | 4.25       | 4.25       | 1.15       | 8.0        | 12.0      | Q2               |

# **PACKAGE MATERIALS INFORMATION**

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#### \*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLK1102ERGER | VQFN         | RGE             | 24   | 3000 | 356.0       | 356.0      | 35.0        |
| TLK1102ERGET | VQFN         | RGE             | 24   | 250  | 210.0       | 185.0      | 35.0        |

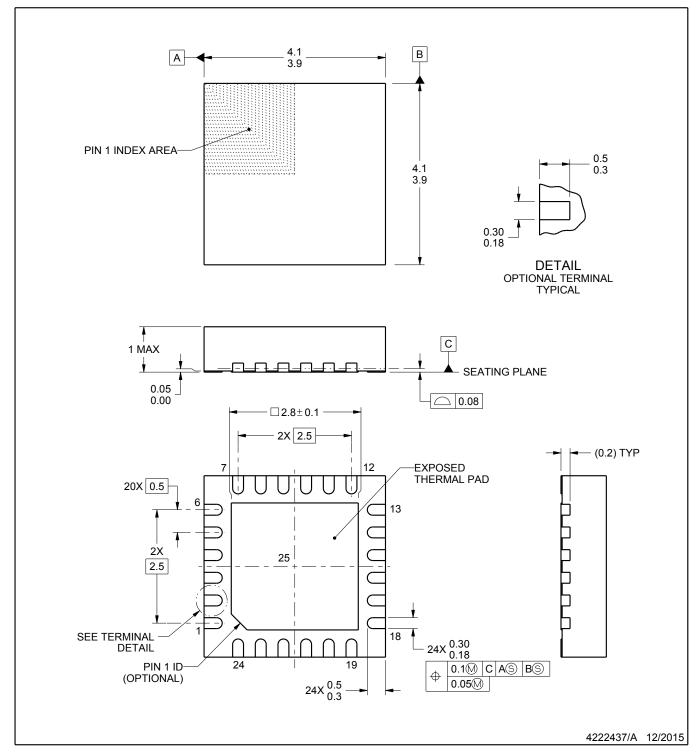


Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4204104/H







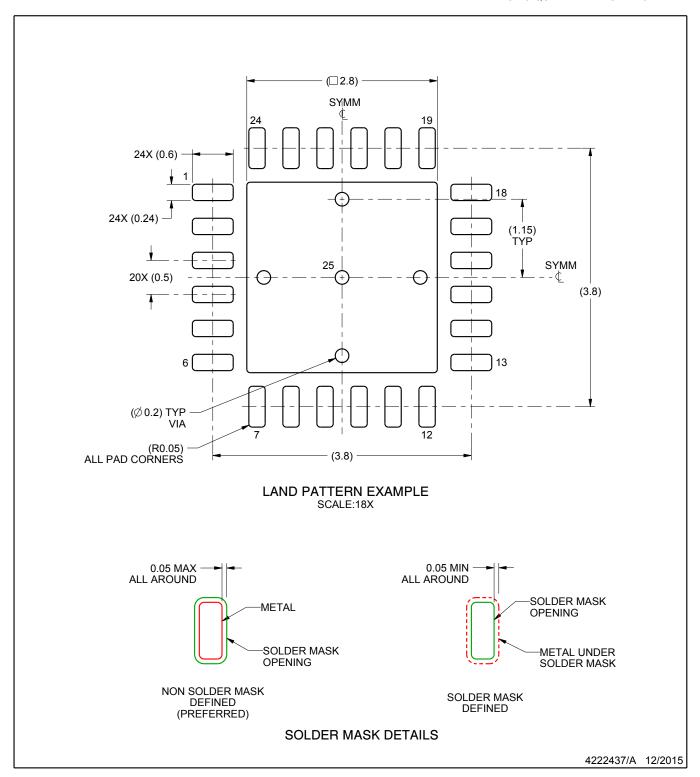
#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

  4. Reference JEDEC registration MO-220.

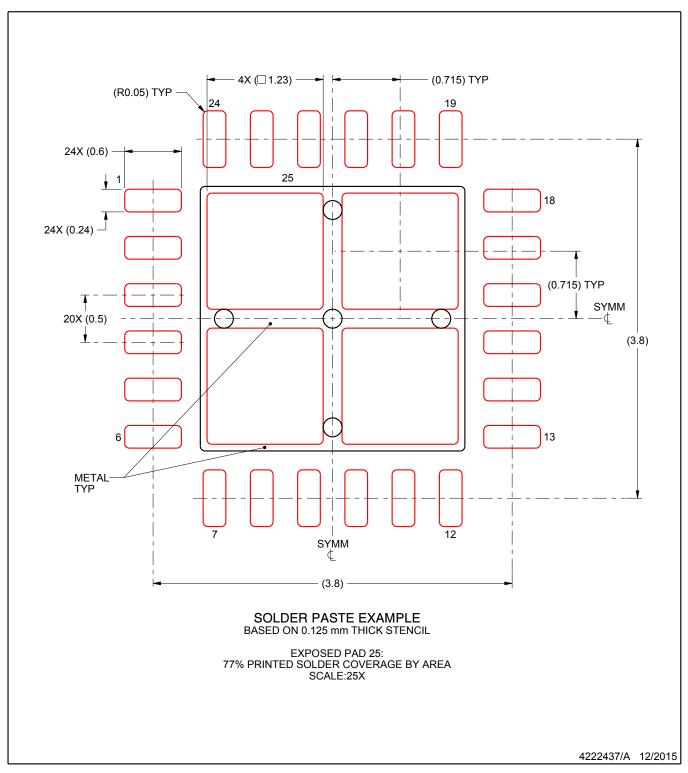




NOTES: (continued)

- 5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 6. Vias are optional depending on application, refer to device data sheet. If some or all are implemented, recommended via locations are shown.





NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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